TOSHIBA 2SK3127

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π-MOS VI)

2 S K 3 1 2 7

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE **APPLICATIONS**

Low Drain-Source ON Resistance : $R_{DS(ON)} = 9.5 \,\mathrm{m}\Omega$ (Typ.)

High Forward Transfer Admittance : $|Y_{fs}| = 38 \,\mathrm{S}$ (Typ.)

Low Leakage Current : $I_{DSS} = 100 \,\mu\text{A}$ (Max.) ($V_{DS} = 30 \,\text{V}$)

Enhancement-Mode : $V_{th} = 1.5 \sim 3.0 \text{ V} \text{ (V}_{DS} = 10 \text{ V}, I_D = 1 \text{ mA)}$

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERIS	SYMBOL	RATING	UNIT			
Drain-Source Voltage	$ m V_{DSS}$	30	V			
Drain-Gate Voltage (RG	$v_{ m DGR}$	30	V			
Gate-Source Voltage	v_{GSS}	±20	V			
Drain Current	DC	$I_{\mathbf{D}}$	45	A		
	Pulse	I_{DP}	135			
Drain Power Dissipation	$P_{\mathbf{D}}$	65	W			
Single Pulse Avalanche Energy**		EAS	524	mJ		
Avalanche Current	I_{AR}	45	A			
Repetitive Avalanche Energy*		E_{AR}	6	mJ		
Channel Temperature		$\mathrm{T_{ch}}$	150	°C		
Storage Temperature Range		$\mathrm{T_{stg}}$	-55~150	°C		

THERMAL CHARACTERISTICS

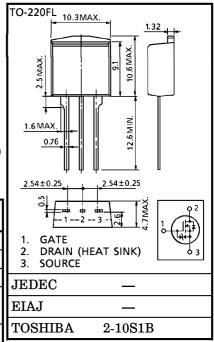
CHARACTERISTIC	SYMBOL	MAX.	UNIT			
Thermal Resistance, Channel to Case	R _{th (ch-c)}		°C/W			
Thermal Resistance, Channel to Ambient	R _{th (ch-a)}	83.3	°C/W			

Note:

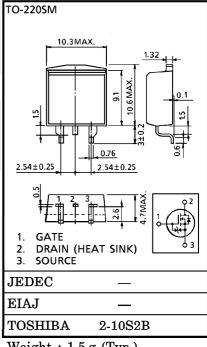
- Repetitive rating; Pulse Width Limited by Max. junction temperature.
- ** V_{DD} = 25 V, T_{ch} = 25°C (initial), L = 186 μH , $R_G = 25 \Omega, I_{AR} = 45 A$

This transistor is an electrostatic sensetive device. Please handle with caution.

INDUSTRIAL APPLICATIONS Unit in mm



Weight: 1.5 g (Typ.)



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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

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CHARA	CTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakag	e Current	$I_{ m GSS}$	$V_{GS} = \pm 16 V, \ V_{DS} = 0 V$	_	_	±10	μ A
Drain Cut-of	f Current	$I_{ m DSS}$	$V_{DS} = 30 \text{ V}, \ V_{GS} = 0 \text{ V}$	_	<u> </u>	100	μ A
Drain-Source Voltage	Breakdown	V (BR) DSS	$I_{D} = 10 \text{ mA}, \ V_{GS} = 0 \text{ V}$	30	_	_	V
Gate Thresh	old Voltage	$ m v_{th}$	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$	1.5	_	3.0	V
Drain-Source	ON Resistance	R _{DS} (ON)	$V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$	_	9.5	12	$\mathbf{m}\Omega$
Forward Tra Admittance	nsfer	Y _{fs}	$V_{ m DS} = 10 \ m V, \ I_{ m D} = 25 \ m A$	19	40	_	S
Input Capacitance Reverse Transfer Capacitance		$\mathrm{C}_{\mathrm{iss}}$	$V_{ m DS} = 10 m V, \ V_{ m GS} = 0 m V, \ f = 1 MHz$	_	2300	_	pF
		C_{rss}		_	380	_	
Output Capa	citance	C_{oss}		_	1100	_	1
Switching Time Fa	Rise Time	$t_{\mathbf{r}}$	$V_{GS} \stackrel{10 \text{ V}}{\circ} V \stackrel{\text{I}_{D} = 25 \text{ A}}{\circ} V_{OUT}$ $R_{L} = 0.6 \Omega$ $V_{DD} = 15 \text{ V}$ $V_{IN} : t_{r}, t_{f} < 5 \text{ ns}$ $Duty \leq 1\%, t_{W} = 10 \mu \text{s}$	_	12	_	
	Turn-on Time	ton		_	25	_	, ng
	Fall Time	tf		_	75	_	ns
	Turn-off Time	toff		_	200	_	
Total Gate Charge (Gate- Source Plus Gate-Drain)		$\mathbf{Q}_{\mathbf{g}}$	$V_{DD} = 24 \text{ V}, V_{GS} = 10 \text{ V}$		66	_	nC
Gate-Source Charge		$\mathbf{Q}_{\mathbf{g}\mathbf{s}}$	$I_{\mathrm{D}}=45~\mathrm{A}$	_	45	_	
Gate-Drain ("Miller") Charge		$\mathbf{Q}_{\mathbf{gd}}$		_	21	_	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	$I_{ m DR}$	_	_	_	45	A
Pulse Drain Reverse Current	$I_{ m DRP}$	_	_	_	135	A
Diode Forward Voltage	$v_{ m DSF}$	$I_{DR} = 45 \text{ A}, V_{GS} = 0 \text{ V}$		_	-1.7	V
Reverse Recovery Time	${ m t_{rr}}$	$I_{DR} = 45 \text{ A}, V_{GS} = 0 \text{ V}$	_	150	_	ns
Reverse Recovery Charge	$Q_{\mathbf{rr}}$	$dI_{DR}/dt = 50 A/\mu s$	_	270	_	nC

MARKING

